



Parameters	Ratings	Units
Blocking Voltage	600	$V_P$
Load Current	150	$mA_{rms} / mA_{DC}$
On-Resistance (max)	22	$\Omega$
LED Current to Operate	5	mA

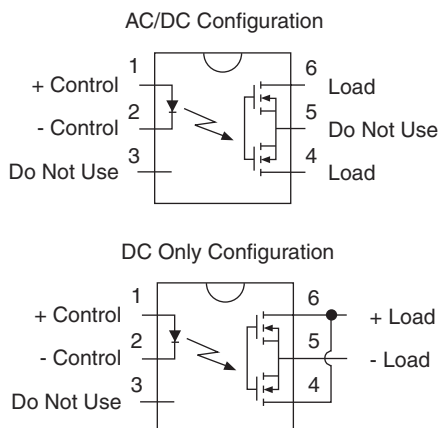
### Features

- PLA192E is 100% Tested for Partial Discharge: DIN EN 60747-5-5
- 5000V<sub>rms</sub> Input/Output Isolation
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 6-Pin Package
- Machine Insertable, Wave Solderable

### Applications

- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment: Patient/Equipment Isolation
- Aerospace
- Industrial Controls

### Pin Configuration



### Description

IXYS Integrated Circuits Division's PLA192 is a single-pole, normally open (1-Form-A) solid state relay that provides 5000V<sub>rms</sub> of input to output isolation.

In addition to all the features and benefits of the PLA192, the PLA192E meets the partial discharge demands of DIN EN 60747-5-5 (previously VDE 0884).

All versions of the PLA192 can be used to replace mechanical relays, while offering the superior reliability associated with semiconductor devices. Optically coupled outputs that use the patented OptoMOS architecture are controlled by a highly efficient GaAlAs infrared LED. Because they have no moving parts, they offer bounce-free switching in more compact surface mount or thru-hole packages.

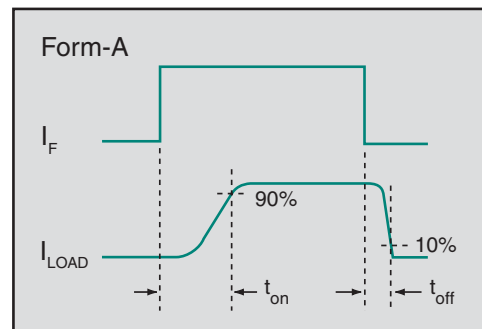
### Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: TUV Certificate B 12 11 82667 002
- DIN EN 60747-5-5 Certified ("E" Suffix Only) VDE Certificate 40036603

### Ordering Information

Part #	Description
PLA192E	6-Pin DIP (50/Tube)
PLA192ES	6-Pin Surface Mount (50/Tube)
PLA192ESTR	6-Pin Surface Mount (1000/Reel)
PLA192	6-Pin DIP (50/Tube)
PLA192S	6-Pin Surface Mount (50/Tube)
PLA192STR	6-Pin Surface Mount (1000/Reel)

### Switching Characteristics of Normally Open Devices



**Absolute Maximum Ratings @ 25°C (Unless Otherwise Noted)**

Parameter	Rating	Units
Blocking Voltage	600	V <sub>P</sub>
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation <sup>1</sup>	150	mW
Total Package Dissipation <sup>2</sup>	800	mW
Isolation Voltage, Input to Output (60 Seconds)	5000	V <sub>rms</sub>
ESD Rating, Human Body Model	4	kV
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

<sup>1</sup> Derate linearly 1.33 mW / °C

<sup>2</sup> Derate linearly 6.67 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

**Electrical Characteristics @ 25°C (Unless Otherwise Noted)**

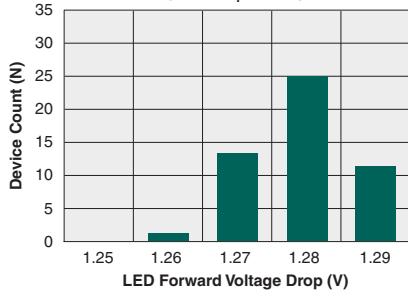
Parameters	Conditions	Symbol	Min	Typ	Max	Units
<b>Output Characteristics</b>						
Load Current						
Continuous, AC/DC Configuration	-	I <sub>L</sub>	-	-	150	mA <sub>rms</sub> / mA <sub>DC</sub>
Continuous, DC-Only Configuration	-	I <sub>L</sub>	-	-	220	mA <sub>DC</sub>
Peak	t=10ms	I <sub>LPK</sub>	-	-	±400	mA <sub>P</sub>
On-Resistance						
AC/DC Configuration	I <sub>L</sub> =150mA	R <sub>ON</sub>	-	13.3	22	Ω
DC-Only Configuration	I <sub>L</sub> =220mA	R <sub>ON</sub>	-	4.15	8	Ω
Off-State Leakage Current	V <sub>L</sub> =600V <sub>P</sub>	I <sub>LEAK</sub>	-	-	1	μA
Switching Speeds						
Turn-On	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>on</sub>	-	-	5	ms
Turn-Off		t <sub>off</sub>	-	-	5	
Output Capacitance	V <sub>L</sub> =50V, f=1MHz	C <sub>OUT</sub>	-	10	-	pF
<b>Input Characteristics</b>						
Input Control Current to Activate	I <sub>L</sub> =100mA	I <sub>F</sub>	-	0.22	5	mA
Input Control Current to Deactivate	-	I <sub>F</sub>	0.1	0.21	-	mA
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.2	1.4	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μA
<b>Common Characteristics</b>						
Input to Output Capacitance	-	C <sub>I/O</sub>	-	3	-	pF

**PLA192E Safety and Insulation Ratings**

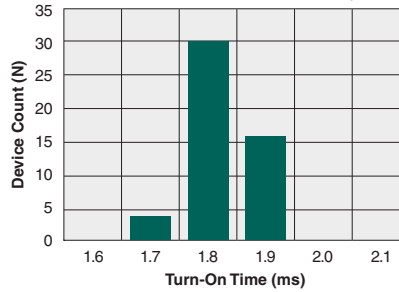
Parameters	Conditions	Symbol	Min	Max	Units
Pollution Degree 2 according to DIN VDE 0109	-	-	-	-	-
Highest Allowable Over-Voltage	Transient Voltage	V <sub>IOTM</sub>	7071	-	V <sub>P</sub>
Maximum Working Insulation Voltage	Recurring Voltage	V <sub>IOORM</sub>	1000	-	V <sub>P</sub>
Partial Discharge Test Voltage	DIN EN 60747-5-5 Method B	V <sub>PR</sub>	-	1875	V <sub>P</sub>
Isolation Test Voltage	-	V <sub>ISO</sub>	-	5000	V <sub>rms</sub>
Creepage Distance	-	-	7.6	-	mm
Clearance Distance	-	-	7.6	-	mm

PERFORMANCE DATA (@ 25°C Unless Otherwise Noted)\*

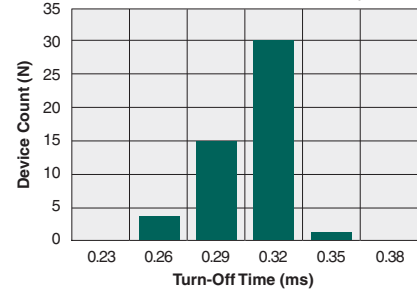
Typical LED Forward Voltage Drop  
(N=50, I<sub>F</sub>=5mA)



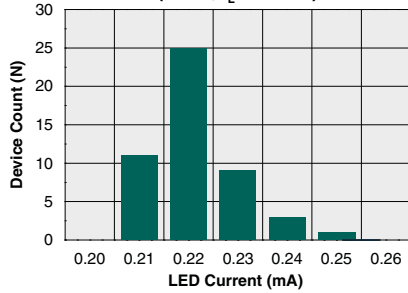
Typical Turn-On Time  
(N=50, I<sub>F</sub>=5mA, I<sub>L</sub>=100mA<sub>DC</sub>)



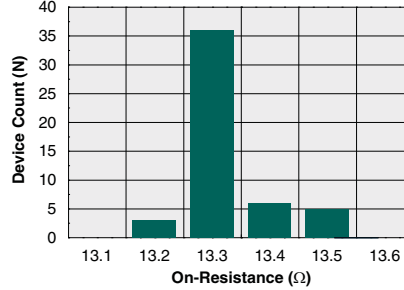
Typical Turn-Off Time  
(N=50, I<sub>F</sub>=5mA, I<sub>L</sub>=100mA<sub>DC</sub>)



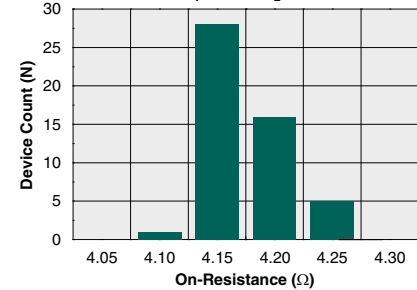
Typical I<sub>F</sub> for Switch Operation  
(N=50, I<sub>L</sub>=100mA)



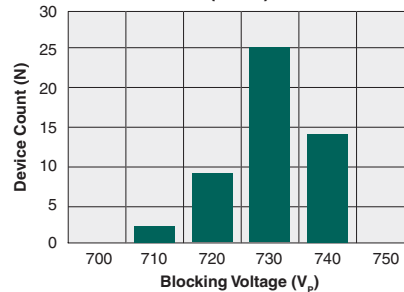
Typical On-Resistance Distribution  
(N=50, I<sub>F</sub>=5mA, I<sub>L</sub>=150mA)



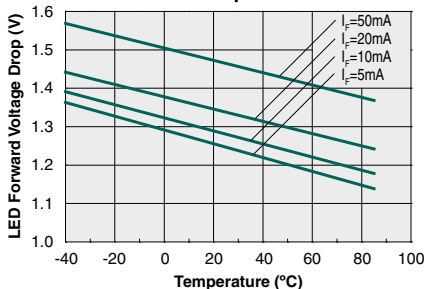
DC-Only On-Resistance Distribution  
(N=50, I<sub>F</sub>=5mA, I<sub>L</sub>=220mA)



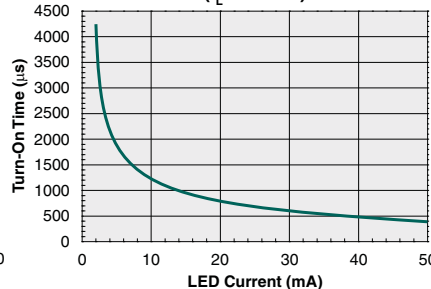
Typical Blocking Voltage Distribution  
(N=50)



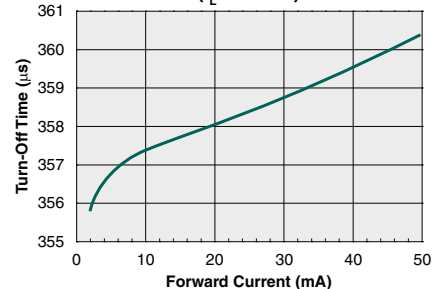
Typical LED Forward Voltage Drop vs. Temperature



Typical Turn-On Time vs. LED Forward Current  
(I<sub>L</sub>=100mA)

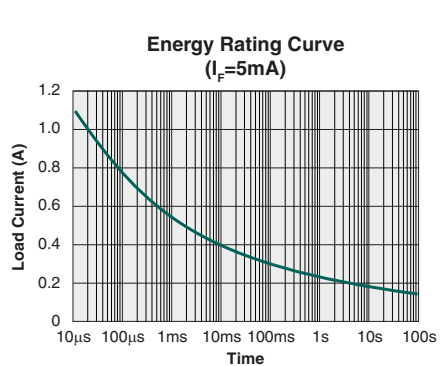
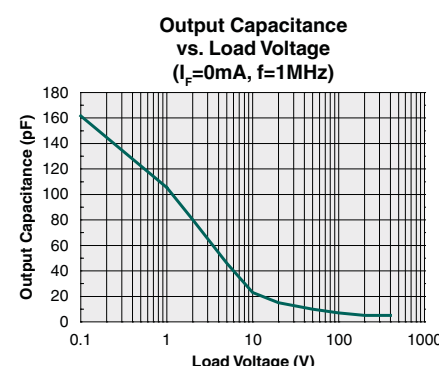
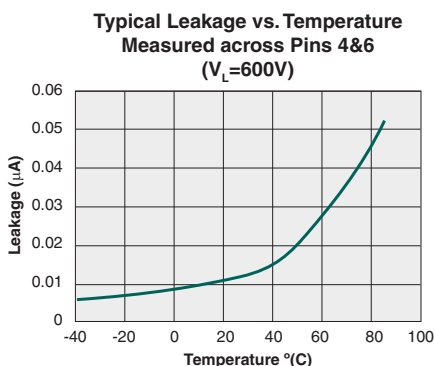
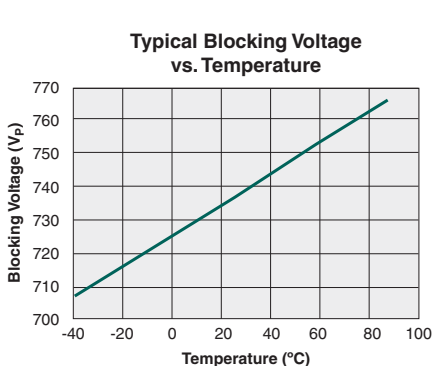
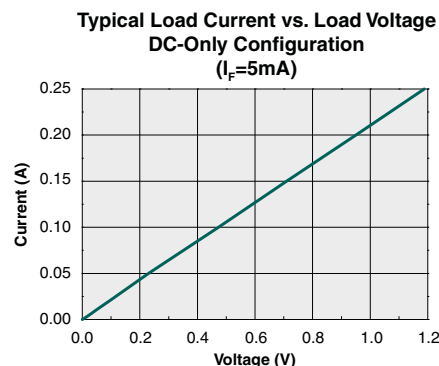
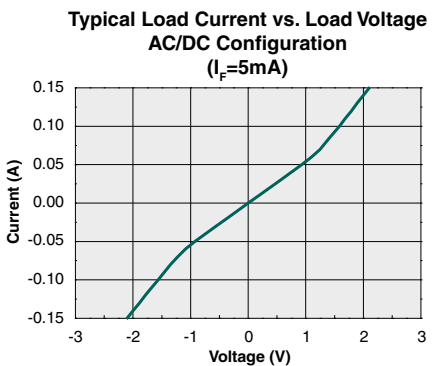
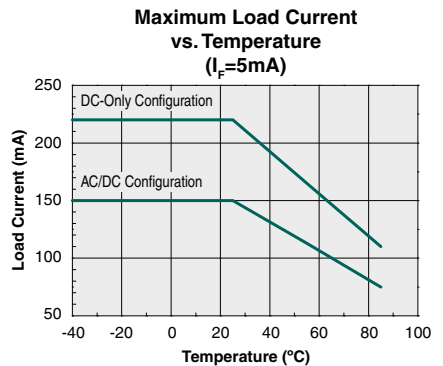
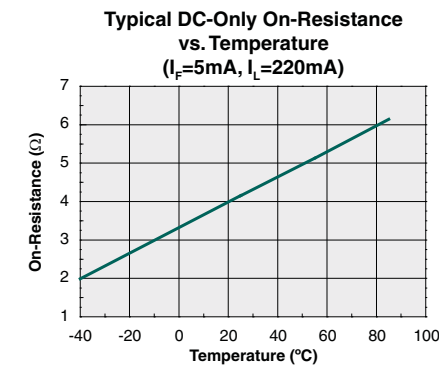
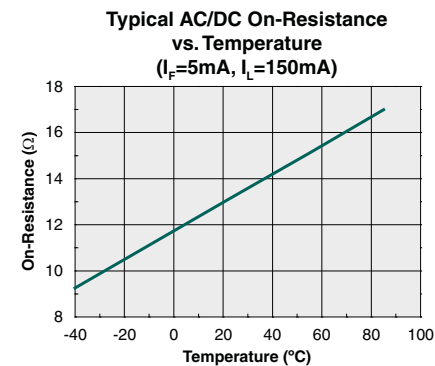
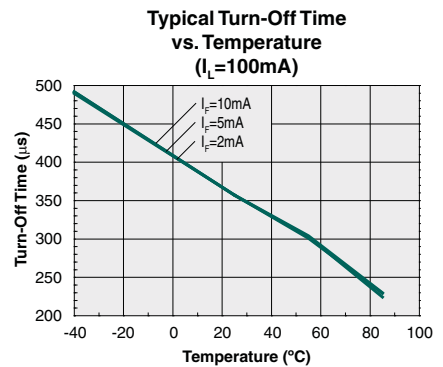
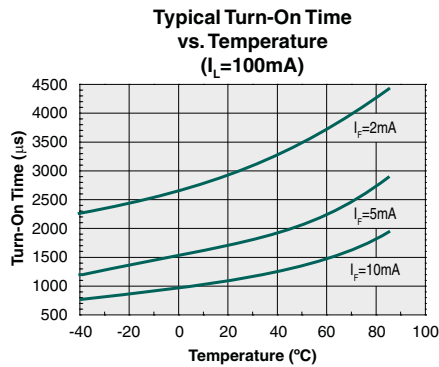
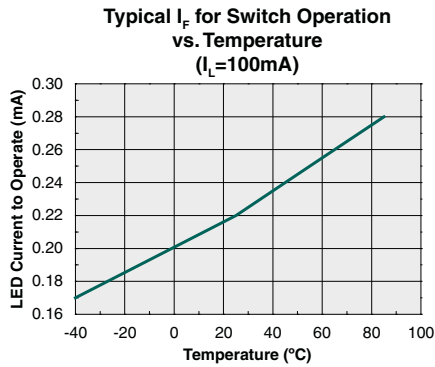


Typical Turn-Off Time vs. LED Forward Current  
(I<sub>L</sub>=100mA)



\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA (@ 25°C Unless Otherwise Noted)\*



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## Manufacturing Information

### Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
All Versions	MSL 1

### ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

### Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
All Versions	250°C for 30 seconds

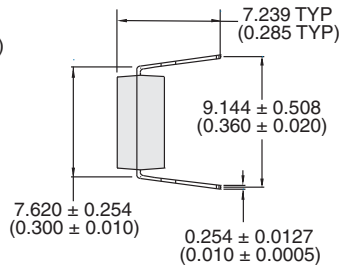
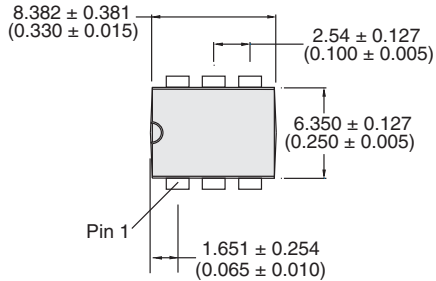
### Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in the standard PLA192 (without the "E" suffix); the use of a short drying bake could be necessary if a wash is used after solder reflow processes. The E-suffix product, being of double-molded construction, does not have the same necessity for a drying bake. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

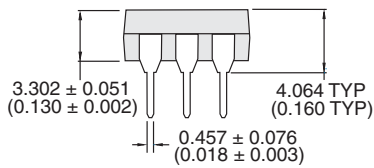
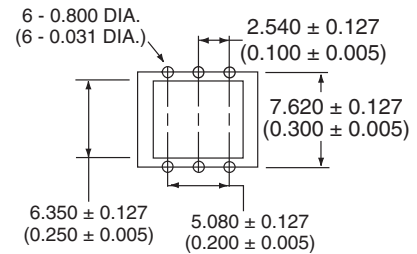


**MECHANICAL DIMENSIONS**

**PLA192 & PLA192E**

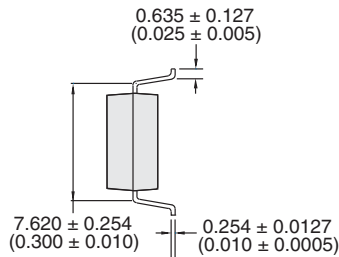
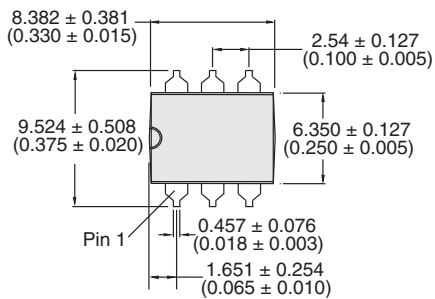


**PCB Hole Pattern**

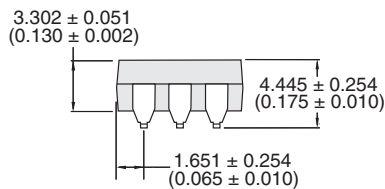
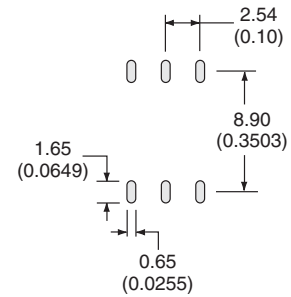


Dimensions  
mm  
(inches)

**PLA192S & PLA192ES**

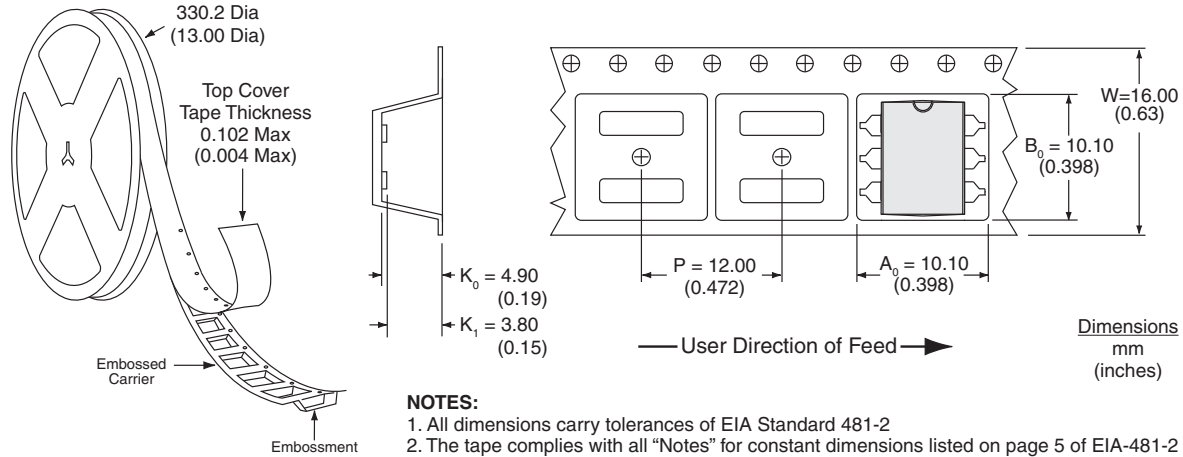


**PCB Land Pattern**



Dimensions  
mm  
(inches)

**PLA192STR & PLA192ESTR Tape & Reel**



**For additional information please visit our website at: [www.ixysic.com](http://www.ixysic.com)**

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- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
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- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

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- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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